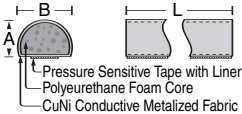




### micro D-shape RFI shielding gaskets

WITH VERY HIGH BOND PRESSURE SENSITIVE ADHESIVE MOUNTING. Very similar to the larger D-shaped shielding gaskets above except that the compression force has been scaled to allow for optimum contact resistance properties on such a small cross-sectional profile. Excellent for omni-directional compression loading from any angle. Popular for groove-mounting or surface mounting. Very High Bond pressure sensitive adhesive cures to full strength within 24 hours exhibiting high-tack properties within a very small area – eliminating the need for space-consuming larger profiles such as P-shapes or various mechanical clip-on configurations.



PART No.	Conductive Surface	Surface Resistivity	A		B		Length
SG125187D-24	CuNi	0.005 - 0.010Ω/lin.in	.125	3,2	.187	4,7	24.0 610
SG125187D-48	CuNi	0.005 - 0.010Ω/lin.in	.125	3,2	.187	4,7	48.0 1220

# Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[LeaderTech:](#)

[SG125187D-24](#) [SG125187D-48](#)